Common Mode Filter with ESD Protection

> 900 MHz Common Mode Stop Band Attenuation for HDMI Interfaces

EMI804x Series

Functional Description

The EMI804x is a family of Common Mode Filters (CMF) with integrated ESD protection, a first in the industry. Differential signaling I/Os can now have both common mode filtering and ESD protection in one package. The EMI804x protects against ESD pulses up to ± 15 kV contact per the IEC61000–4–2 standard.

The EMI804x is well-suited for protecting systems using high-speed differential ports such as USB 3.0, HDMI 1.3/1.4/2.0; corresponding ports in removable storage and other applications.

The EMI804x is available in a RoHS-compliant, XDFN6 for 1 Differential Pair, XDFN10 for 2 Differential Pair and XDFN16 package for 3 Differential Pair.

Features

- Total Insertion Loss $DM_{LOSS} < 2.5 \text{ dB}$ at 2.5 GHz
- Large Differential Mode Cutoff Frequency $f_{3dB} > 5$ GHz
- High Common Mode Stop Band Attenuation: 15 dB at 700 MHz, 30 dB at 2.4 GHz
- Low Channel Resistance 6.0 Ω
- Provides ESD Protection to IEC61000–4–2 Level 4, ±15 kV Contact
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- USB 3.0
- HDMI 1.3/1.4/2.0
- MHL 2.0
- ESATA
- Automotive Cameras

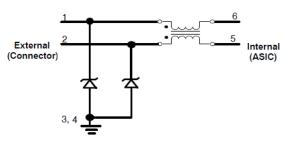


Figure 1. EMI8041 Electrical Schematic



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CASE 711AY

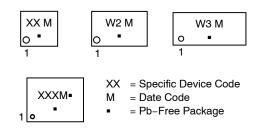
XDFN16 CASE 711AZ

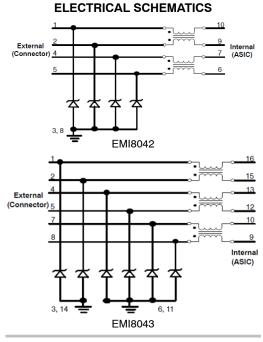


CASE 711AX

UDFN6 CASE 517DG

MARKING DIAGRAMS





ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

PIN FUNCTION DESCRIPTION

	Device Pin				
Pin Name	EMI8041	EMI8042	EMI8043	Туре	Description
ln_1+	1	1	1	I/O	CMF Channel 1+ to Connector (External)
ln_1-	2	2	2	I/O	CMF Channel 1- to Connector (External)
Out_1+	6	10	16	I/O	CMF Channel 1+ to ASIC (Internal)
Out_1-	5	9	15	I/O	CMF Channel 1- to ASIC (Internal)
ln_2+	NA	4	4	I/O	CMF Channel 2+ to Connector (External)
ln_2-	NA	5	5	I/O	CMF Channel 2- to Connector (External)
Out_2+	NA	7	13	I/O	CMF Channel 2+ to ASIC (Internal)
Out_2-	NA	6	12	I/O	CMF Channel 2- to ASIC (Internal)
ln_3+	NA	NA	7	I/O	CMF Channel 3+ to Connector (External)
ln_3-	NA	NA	8	I/O	CMF Channel 3- to Connector (External)
Out_3+	NA	NA	10	I/O	CMF Channel 3+ to ASIC (Internal)
Out_3-	NA	NA	9	I/O	CMF Channel 3- to ASIC (Internal)
VN	3,4	3, 8	3,6,14,11	GND	Ground

ABSOLUTE MAXIMUM RATINGS (TA = 25° C unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Temperature Range	T _{OP}	-40 to +85	°C
Storage Temperature Range	T _{STG}	−65 to +150	°C
Maximum Lead Temperature for Soldering Purposes (1/8" from Case for 10 seconds)	ΤL	260	°C
DC Current per Line	I _{LINE}	100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

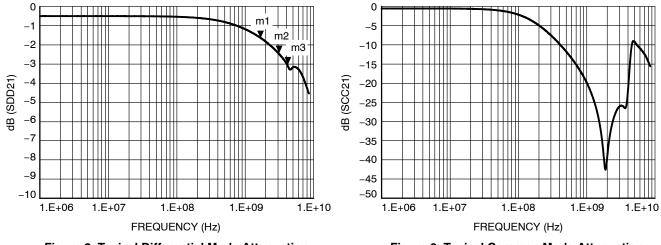
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{RWM}	Reverse Working Voltage	(Note 3)		3.3		V
V_{BR}	Breakdown Voltage	I _T = 1 mA; (Note 4)	4.0		9.0	V
I _{LEAK}	Channel Leakage Current	$T_A = 25^{\circ}C, V_{IN} = 3.3 V, GND = 0 V$			1.0	μA
R _{CH}	Channel Resistance (Pins 1–6, 2–5) – EMI8041 (Pins 1–10, 2–9, 4–7 and 5–6) – EMI8042 (Pins 1–16, 2–15, 4–13, 5–12, 7–10 and 8–9) – EMI8043			6.0		Ω
DM_{LOSS}	Differential Mode Insertion Loss	@ 2.5 GHz		2.5		dB
f _{3dB}	Differential Mode Cut-off Frequency	50 Ω Source and Load Termination		5.0		GHz
F _{atten}	Common Mode Stop Band Attenuation	@ 700 MHz		15		dB
V _{ESD}	In-system ESD Withstand Voltage a) Contact discharge per IEC 61000-4-2 standard, Level 4 (External Pins) b) Contact discharge per IEC 61000-4-2 standard, Level 1 (Internal Pins)	(Notes 1 and 2)	±15 ±2			kV
V _{CL}	TLP Clamping Voltage	Forward $I_{PP} = 8 A$ Forward $I_{PP} = 16 A$ Forward $I_{PP} = -8 A$ Forward $I_{PP} = -16 A$		7.26 11.8 -3.5 -6.7		V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
1. Standard IEC61000-4-2 with C_{Discharge} = 150 pF, R_{Discharge} = 330, GND grounded.
2. These measurements performed with no external capacitor.
3. TVS devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal to or greater than the DC or continuous peak operating voltage level.

or continuous peak operating voltage level. 4. V_{BR} is measured at pulse test current I_T.

TYPICAL CHARACTERISTICS







Interface	Data Rate (Gb/s)	Fundamental Frequency (GHz)	EMI804x Insertion Loss (dB)
HDMI 1.3/1.4	3.4	1.7 (m1)	m1 = 1.65
USB 3.0	5.0	2.5 (m2)	m2 = 2.13
HDMI 2.0	6.0	3.0 (m3)	m3 = 2.41

TRANSMISSION LINE PULSE (TLP) MEASUREMENTS

Transmission Line Pulse (TLP) provides current versus voltage (I–V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 4. TLP I–V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10 s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 5 where an 8 kV IEC61000–4–2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels. Typical TLP I–V curves for the EMI804x are shown in Figure 4.

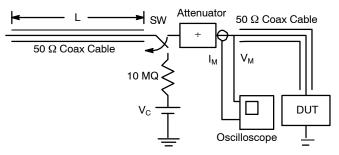


Figure 4. Simplified Schematic of a Typical TLP System

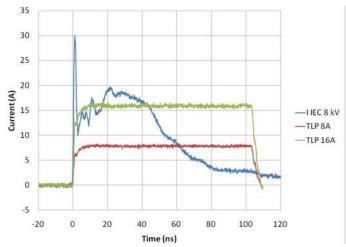
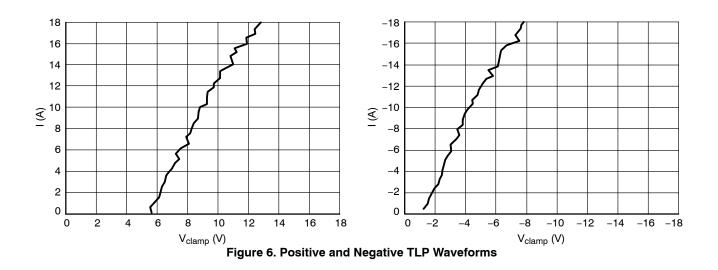


Figure 5. Comparison Between 8 kV IEC61000-4-2 and 8 A and 16 A TLP Waveforms



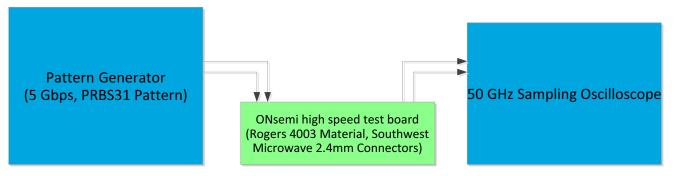


Figure 7. Eye Diagram Test Setup for 5Gbps Data Rate

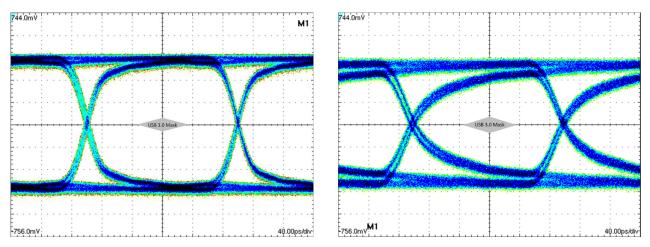


Figure 8. Eye Diagram 5Gbps with and without EMI804x

	Eye Height (mVppd)	Rise Time (ps)	Fall Time (ps)	Jrms (ps)	Jpp (ps)
Reference (No Device)-Left Figure	724	30.4	29.6	1.997	9.6
EMI804x Right Figure	405	60	60.8	3.484	16

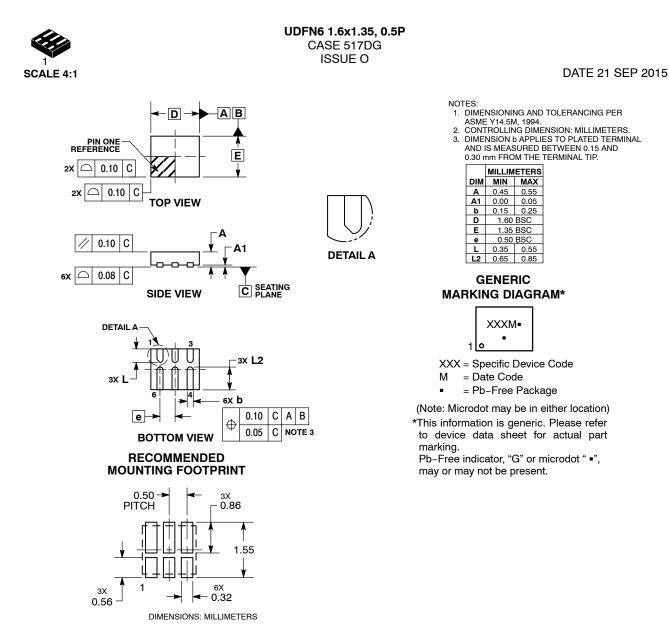
ORDERING INFORMATION

Orderable Part Number	Marking	Package	Shipping [†]
EMI8041MUTAG, SZEMI8041MUTAG*	WA	XDFN6 (Pb–Free)	3000 / Tape & Reel
EMI8042MUTAG, SZEMI8042MUTAG*	W2	XDFN10 (Pb-Free)	3000 / Tape & Reel
EMI8043MUTAG, SZEMI8043MUTAG*	W3	XDFN16 (Pb–Free)	3000 / Tape & Reel
EMI8041BMUTAG	МА	UDFN6 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.





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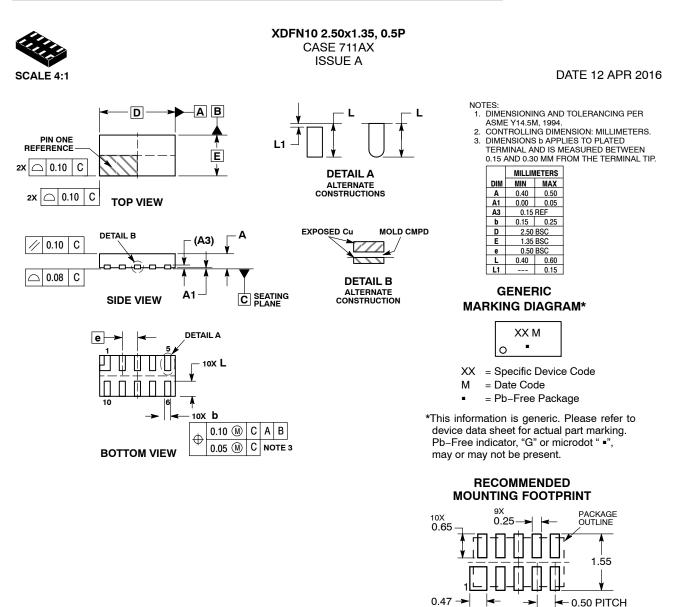
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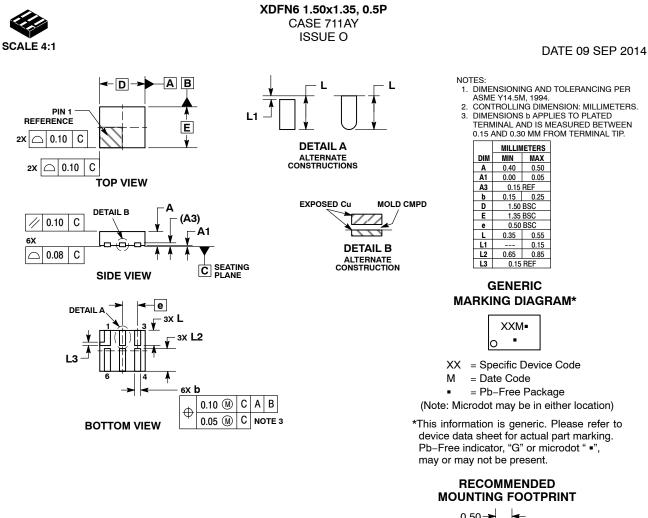


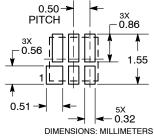


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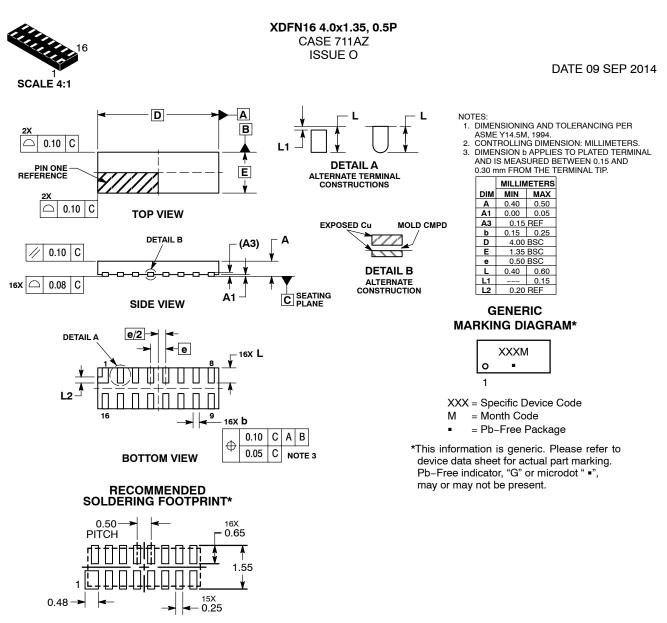






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